L Number	Hits	Search Text	DB	Time stamp
1	235	(438/674).CCLS.	USPAT;	2004/07/12
			US-PGPUB;	10:10
			EPO; JPO;	
			DERWENT;	
2	1	((438/674).CCLS.) and (((438/612) or	IBM_TDB USPAT;	2004/07/12
	1	(438/613) or (438/614)).CCLS.) and	US-PGPUB;	2004/07/12
	İ	(electrolyt\$2 same (ni or nickel))	EPO; JPO;	10.10
			DERWENT;	
_	2	interconnect and and colored value	IBM_TDB	
		interconnect and pad and (electrolyt\$2 near7 (ni or nickel)) and (resist or	USPAT; US-PGPUB;	2004/07/10
		photoresist) and ((front and back) near5	EPO; JPO;	19.12
		(substrate or wafer))	DERWENT;	
_	100	/5mm+44	IBM_TDB	
	182	(front\$4 near5 (substrate or wafer)) and (back\$4 near5 (substrate or wafer)) and	USPAT;	2004/07/10
		(electrolyt\$3 same (nickel or ni))	US-PGPUB; EPO; JPO;	19:18
		(1120102 02 112))	DERWENT;	
			IBM TDB	
-	229		USPAT;	2004/07/10
		((back\$4 or rear) near5 (substrate or wafer)) and (electrolyt\$3 same (nickel or	US-PGPUB;	19:33
	1	ni))	EPO; JPO; DERWENT;	
			IBM TDB	
-	35		USPĀT;	2004/07/10
		((back\$4 or rear) near5 (substrate or wafer)) and (electrolyt\$3 same (nickel or	US-PGPUB;	19:20
		ni)) ) and (pad same (front\$4 near5	EPO; JPO; DERWENT;	
		(substrate or wafer))) and (pad same	IBM TDB	
		((back\$4 or rear) near5 (substrate or	_	
_	18	<pre>  wafer)))   (((front\$4 near5 (substrate or wafer))</pre>		
		and ((back\$4 or rear) near5 (substrate or	USPAT; US-PGPUB;	2004/07/10
		wafer)) and (electrolyt\$3 same (nickel or	EPO; JPO;	19:26
		ni)) ) and (pad same (front\$4 near5	DERWENT;	
		(substrate or wafer))) and (pad same	IBM_TDB	
		((back\$4 or rear) near5 (substrate or wafer)))) and (pad same (resist or		
		photoresist))		
-	14737	((438/107) or (438/108) or (438/128) or	USPAT;	2004/07/10
		(438/129) or (438/612) or (438/613) or	US-PGPUB;	19:33
		(438/614) or (438/617) or (257/777) or (257/778) or (257/779) or (257/780) or	EPO; JPO;	
İ	j :	(257/781) or (257/782) or (257/784) or	DERWENT; IBM TDB	
	1	(257/786)).CCLS.		
-	224	"6" and (front\$4 near5 (substrate or	USPAT;	2004/07/10
		<pre>wafer)) and ((back\$4 or rear) near5 (substrate or wafer)) and (electrolyt\$3</pre>	US-PGPUB;	19:34
		same (nickel or ni))	EPO; JPO; DERWENT;	
		4444004000	IBM_TDB	
-	12	(((438/107) or (438/108) or (438/128) or (438/129) or (438/129)	USPĀT;	2004/07/10
		(438/129) or (438/612) or (438/613) or (438/614) or (438/617) or (257/777) or	US-PGPUB;	19:38
		(257/778) or (257/779) or (257/780) or	EPO; JPO; DERWENT;	
		(257/781) or (257/782) or (257/784) or	IBM_TDB	
		(257/786)).CCLS.) and (front\$4 near5	_	
		(substrate or wafer)) and ((back\$4 or rear) near5 (substrate or wafer)) and		
		(electrolyt\$3 same (nickel or ni))		
-	29	(((438/107) or (438/108) or (438/128) or	USPAT;	2004/07/10
		(438/129) or (438/612) or (438/613) or	US-PGPUB;	19:38
		(438/614) or (438/617) or (257/777) or (257/778) or (257/779) or (257/780) or	EPO; JPO;	
		(257/781) or (257/782) or (257/784) or	DERWENT; IBM TDB	
		(257/786)).CCLS.) and ((front\$4 or top)		
	1	near5 (substrate or wafer)) and ((back\$4)		
		or rear) near5 (substrate or wafer)) and (electrolyt\$3 same (nickel or ni))		
·		, OI ITCKET OF III)		

Search History 7/12/04 10:11:04 AM Page 1

(438/129) or (438/612) or (438/613) or (438/614) or (438/614) or (257/777) or (257/778) or (257/778) or (257/778) or (257/784) or (257/786)).CCLS.) and ((front\$4 or top) near5 (substrate or wafer)) and ((back\$4 or rear) near5 (substrate or wafer)) and (electrolyt\$3 same (nickel or ni)) not (((438/107) or (438/612) or (438/613) or (438/128) or (257/786) or (257/789) or (257/779) or (257/784) or (257/781) or (257/779) or (257/784) or (257/788) or (257/779) or (257/784) or (257/786)).CCLS.) and (front\$4 near5 (substrate or wafer)) and (electrolyt\$3 same (nickel or ni)) ((438/612) or (438/613) or (438/612) or (438/613) or (438/614)).CCLS.  4467  4467  4467  4467  ((((438/612) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel))  (((((438/612) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel))  (((((438/612) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel))  (((((438/612) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel))  ((((((438/612) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel)))  ((((((((438/612) or (438/613) or (438/614)).CCLS.)) and (electrolyt\$2 same (ni or nickel)))  (((((((((((((((((((((((((((((((((					
(438/614) or (438/617) or (257/777) or (257/778) or (257/778) or (257/779) or (257/778) or (257/778) or (257/781) or (257/782) or (257/784) or (257/786) or (257/786) or (257/786) or (257/786) or (257/781) or (257/782) and ((back\$4 or rear) near5 (substrate or wafer)) and (electrolyt\$3 same (nickel or ni)) not (((438/129) or (438/612) or (438/613) or (438/614) or (257/779) or (257/779) or (257/779) or (257/779) or (257/779) or (257/782) or (257/780) or (257/781) or (257/782) or (257/784) or (257/782) or (257/784) or (257/782) or (257/784) or (257/782) and (front\$4 near5 (substrate or wafer)) and (electrolyt\$3 same (nickel or ni)) ((438/612) or (438/613) or (438/614)).CCLS.   USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB (438/614)).CCLS.   USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB (100/100)   USPAT; USP	-	17	((((438/107) or (438/108) or (438/128) or	USPAT;	2004/07/10
(257/778) or (257/779) or (257/780) or (257/781) or (257/781) or (257/782) or (257/784) or (257/786)).CCLS.) and ((front\$4 or top) near5 (substrate or wafer)) and (electrolyt\$3 same (nickel or ni)) not ((((438/107) or (438/108) or (438/128) or (438/614) or (438/617) or (257/778) or (257/782) or (257/784) or (257/786)).CCLS.) and (front\$4 near5 (substrate or wafer)) and (electrolyt\$3 same (nickel or ni)) ((438/612) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (nickel)) uspat; (1848/614)).CCLS.) and (electrolyt\$2 same (ni or nickel))  71  ((((438/612) or (438/613) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel)) uspat; (1848/614)).CCLS.) and (electrolyt\$2 same (ni or nickel)) and (resist or photoresist) uspat; (1848/614)).CCLS.) and (electrolyt\$2 same (ni or nickel))) uspat; (1848/614)).CCLS.) and (electrolyt\$2 same (ni or nickel)) uspat; (1848/614)).CCLS.)		(438/129) or (438/612) or (438/613) or	US-PGPUB;	19:44	
(257/778) or (257/779) or (257/780) or (257/781) or (257/781) or (257/782) or (257/784) or (257/786)).CCLS.) and ((front\$4 or top) near5 (substrate or wafer)) and (electrolyt\$3 same (nickel or ni)) not ((((438/107) or (438/108) or (438/128) or (438/614) or (438/612) or (438/613) or (257/778) or (257/778) or (257/778) or (257/778) or (257/778) or (257/782) or (257/784) or (257/786)).CCLS.) and (front\$4 near5 (substrate or wafer)) and (electrolyt\$3 same (nickel or ni)) ((438/612) or (438/613) or (438/614)).CCLS.) and (font\$4 near5 (substrate or wafer)) and (electrolyt\$3 same (nickel or ni)) ((438/612) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel))  92 (((438/612) or (438/613) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel)) ((((438/612) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel)) ((((438/612) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel)) ((((438/612) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel))) ((((638/612) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel))) ((((638/612) or (438/613) or (638/614)).CCLS.) and (electrolyt\$2 same (ni or nickel))) ((((638/612) or (438/613) or (638/614)).CCLS.) and (electrolyt\$2 same (ni or nickel))) ((((638/612) or (438/613) or (638/614)).CCLS.) (((638/612) or (638/613) or (638/614)).CCLS.) (((638/612) or (638/613) or (638/614)).CCLS.) (((638/613) or (638/614)).CCLS.) (((63			(438/614) or (438/617) or (257/777) or	EPO; JPO;	
(257/781) or (257/782) or (257/784) or (257/786)).CCLS.) and ((front\$4 or top) near5 (substrate or wafer)) and ((back\$4 or rear) near5 (substrate or wafer)) and (electrolyt\$3 same (nickel or ni)) not (((438/107) or (438/108) or (438/128) or (438/129) or (438/613) or (438/614) or (257/780) or (257/778) or (257/779) or (257/7784) or (257/7781) or (257/782) or (257/784) or (257/786)).CCLS.) and (front\$4 near5 (substrate or wafer)) and (electrolyt\$3 same (nickel or ni)) ((438/612) or (438/613) or (438/614)).CCLS.) and (front\$4 near5 (substrate or wafer)) and (electrolyt\$3 same (nickel or ni)) ((438/612) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel)) ((438/612) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel)) ((((438/612) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel)) ((((438/612) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel))) ((((388/612) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel))) and (resist or photoresist)	1		(257/778) or (257/779) or (257/780) or	DERWENT:	
(257/786)).CCLS.) and ((front\$4 or top) near5 (substrate or wafer)) and ((back\$4 or rear) near5 (substrate or wafer)) and (electrolyt\$3 same (nickel or ni)) not ((((438/107) or (438/108) or (438/128) or (438/129) or (438/612) or (438/613) or (257/778) or (257/779) or (257/770) or (257/778) or (257/779) or (257/780) or (257/781) or (257/782) or (257/780) or (257/786)).CCLS.) and (front\$4 near5 (substrate or wafer)) and ((back\$4 or rear) near5 (substrate or wafer)) and (electrolyt\$3 same (nickel or ni))) (438/612) or (438/613) or (438/614)).CCLS.  92 (((438/612) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel))  ((((438/612) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel))  ((((438/612) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel)) and (resist or photoresist)  71 ((((438/612) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel))) and (resist or photoresist)  72 (304/07/12 (35-26PUB; EPO; JPO; DERWENT;			(257/781) or (257/782) or (257/784) or		
near5 (substrate or wafer)) and ((back\$4 or rear) near5 (substrate or wafer)) and (electrolyt\$3 same (nickel or ni)) ) not ((((438/107) or (438/108) or (438/128) or (438/612) or (438/613) or (257/778) or (257/778) or (257/778) or (257/780) or (257/784) or (257/781) or (257/782) or (257/784) or (257/786)).CCLS.) and (front\$4 near5 (substrate or wafer)) and (electrolyt\$3 same (nickel or ni)) ) ((438/612) or (438/613) or (438/614)).CCLS.) (438/613) or (438/614)).CCLS.  92 (((438/612) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel))			(257/786)).CCLS.) and ((front\$4 or top)		
or rear) near5 (substrate or wafer) and (electrolyt\$3 same (nickel or ni)) not ((((438/612) or (438/108) or (438/128) or (438/129) or (438/612) or (438/613) or (257/781) or (257/780) or (257/780) or (257/781) or (257/782) or (257/784) or (257/786)).CCLS.) and (front\$4 near5 (substrate or wafer)) and (electrolyt\$3 same (nickel or ni)) ) ((438/612) or (438/613) or (438/614)).CCLS.  4467 (438/612) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel))  - 92 (((438/612) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel))  - 71 ((((438/612) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel)) uspar; Uspar;			near5 (substrate or wafer)) and ((back\$4		
(electrolyt\$3 same (nickel or ni)) not ((((438/107) or (438/108) or (438/128) or (438/129) or (438/612) or (438/613) or (438/614) or (257/779) or (257/777) or (257/778) or (257/779) or (257/780) or (257/781) or (257/782) or (257/784) or (257/786)).CCLS.) and (front\$4 near5 (substrate or wafer)) and (back\$4 or rear) near5 (substrate or wafer)) and (electrolyt\$3 same (nickel or ni))) (438/612) or (438/613) or (438/614)).CCLS.  92 (((438/612) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel))  71 ((((438/612) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel)) and (resist or photoresist)  10 (004/07/12 10:07  10 (10:07  10 (10:07  10 (10:07  10 (10:07  10 (10:07  10 (10:07  10 (10:07  10 (10:07			or rear) near5 (substrate or wafer)) and		
((((438/107) or (438/108) or (438/128) or (438/129) or (438/612) or (438/613) or (438/614) or (438/617) or (257/777) or (257/778) or (257/778) or (257/780) or (257/784) or (257/781) or (257/782) or (257/784) or (257/784) or (257/786).CCLS.) and (front\$4 near5 (substrate or wafer)) and (electrolyt\$3 same (nickel or ni)) ((438/612) or (438/613) or (438/612) or (438/613) or (438/614)).CCLS.  92 (((438/612) or (438/613) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel))  - 71 ((((438/612) or (438/613) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel)) and (electrolyt\$2 same (ni or nickel)) and (electrolyt\$2 same (ni or nickel))) and (resist or photoresist)  - 72 (((438/612) or (438/613) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel))) and (resist or photoresist)		ľ	(electrolyts3 same (nickel or ni)) ) not		ļ
(438/614) or (438/612) or (438/613) or (438/614) or (438/617) or (257/777) or (257/778) or (257/781) or (257/782) or (257/784) or (257/784) or (257/786)).CCLS.) and (front\$4 near5 (substrate or wafer)) and (electrolyt\$3 same (nickel or ni)) (438/612) or (438/613) or (438/614)).CCLS.  92 (((438/612) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel))  71 ((((438/612) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel))  71 (((((438/612) or (438/613) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel)) and (resist or photoresist)  PO ((((388/612) or (438/613) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel)) and (resist or photoresist)	l		((((438/107)  or  (438/108)  or  (438/128)  or		
(438/614) or (438/617) or (257/777) or (257/778) or (257/778) or (257/7780) or (257/780) or (257/781) or (257/782) or (257/780) or (257/784) or (257/786)).CCLS.) and (front\$4 near5 (substrate or wafer)) and (electrolyt\$3 same (nickel or ni)))  (4467 (438/612) or (438/613) or (438/614)).CCLS.  92 (((438/612) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel))  71 (((((438/612) or (438/613) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel))  (((((438/612) or (438/613) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel)) and (resist or photoresist)  PART: USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;			(438/129) or $(438/612)$ or $(438/613)$ or		
(257/778) or (257/779) or (257/780) or (257/781) or (257/781) or (257/784) or (257/786)).CCLS.) and (front\$4 near5 (substrate or wafer)) and (electrolyt\$3 same (nickel or ni)) ((438/612) or (438/613) or (438/614)).CCLS.  92 (((438/612) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel))  - 71 ((((438/612) or (438/613) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel))  - ((((438/612) or (438/613) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel)) and (resist or photoresist)  - (10 ((438/612) or (438/613) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel))) and (resist or photoresist)			(438/614) or (438/617) or (257/777) or		l
(257/781) or (257/782) or (257/784) or (257/786)).CCLS.) and (front\$4 near5 (substrate or wafer)) and (back\$4 or rear) near5 (substrate or wafer)) and (electrolyt\$3 same (nickel or ni)) ((438/612) or (438/613) or (438/614)).CCLS.  92 (((438/612) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel))  71 ((((438/612) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel)) and (resist or photoresist)  72 (((438/612)) and (resist or photoresist)  93 (((438/612)) or (438/613) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel))) and (resist or photoresist)  94 (((438/612)) or (438/613) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel))) and (resist or photoresist)  95 (((438/612)) or (438/613)) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel))) and (resist or photoresist)		ļ	(257/778) or (257/779) or (257/779) or		
(257/786)).CCLS.) and (front\$4 near5 (substrate or wafer)) and ((back\$4 or rear) near5 (substrate or wafer)) and (electrolyt\$3 same (nickel or ni)) ((438/612) or (438/613) or (438/614)).CCLS.			(257/781) or (257/782) or (257/784) or		
(substrate or wafer)) and ((back\$4 or rear) near5 (substrate or wafer)) and (electrolyt\$3 same (nickel or ni)))  ((438/612) or (438/613) or (438/614)).CCLS.  92 (((438/612) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel))  71 ((((438/612) or (438/613) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel))  71 ((((438/612) or (438/613) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel))) and (resist or photoresist)  Provided Park (ni or nickel)) and (resist or photoresist)    ((((438/612) or (438/613) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel))) and (resist or photoresist)    ((((438/612) or (438/613) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel))) and (resist or photoresist)    (((((438/612) or (438/613) or (438/613) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel))) and (resist or photoresist)			(257/761) OI (257/762) OI (257/764) OI		
rear) near5 (substrate or wafer)) and (electrolyt\$3 same (nickel or ni)))  ((438/612) or (438/613) or (438/614)).CCLS.  92 (((438/612) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel))  71 ((((438/612) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel))  72 ((((438/612) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel))) and (resist or photoresist)  73 ((((438/612) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel))) and (resist or photoresist)  74 ((((438/612) or (438/613) or (438/613)) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel))) and (resist or photoresist)  75 ((((438/612) or (438/613)) or (438/613)) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel))) and (resist or photoresist)			(substrate on wafer)		
- 4467 (electrolyt\$3 same (nickel or ni))) ((438/612) or (438/613) or (438/614)).CCLS.  92 (((438/612) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel))  71 ((((438/612) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (18M TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT; IBM TDB USPAT; US-PGPUB; ID:10  71 ((((438/612) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel))) and (resist or photoresist)  Page 19:45  2004/07/12 10:10  2004/07/12 10:07			rear) nears (substrate as a section)		
- 4467 ((438/612) or (438/613) or (438/614)).CCLS. USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT; (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel))  - 71 ((((438/612) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel))) and (resist or photoresist)    2004/07/12   2004/07/12   10:10			(clast meals (substrate or water)) and		
- 92 (((438/612) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel))  71 ((((438/612) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (438/614)).CCLS.) and (electrolyt\$2 same (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel))) and (resist or photoresist)  US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; ID:07  US-PGPUB; EPO; JPO; DERWENT; US-PGPUB; EPO; JPO; DERWENT;	_	1167	(420/612) (420/612)		
92 (((438/612) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel))  71 ((((438/612) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel))) and (resist or photoresist)  19.43  EPO; JPO; DERWENT; IBM_TDB US-PGPUB; US-PGPUB; ID:07  US-PGPUB; EPO; JPO; DERWENT; IBM_TDB US-PGPUB; ID:07	_	440/			
- 92 (((438/612) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel))  - 71 ((((438/612) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (10:10)  - (438/614)).CCLS.) and (electrolyt\$2 same (10:07)  - (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel))) and (resist or photoresist)  - DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	ŀ	1	(438/614)).CCLS.		19:45
- 92 (((438/612) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel))  - 71 ((((438/612) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel))) and (resist or photoresist)    IBM_TDB		-			
92 (((438/612) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel))  71 ((((438/612) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (138/614)).CCLS.) and (electrolyt\$2 same (ni or nickel))) and (resist or photoresist)  92 (((438/612) or (438/613) or (USPAT; USPAT; U				DERWENT;	
(438/614)).CCLS.) and (electrolyt\$2 same (ini or nickel))  ((((438/612) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (ini or nickel))) and (resist or photoresist)  (338/614)).CCLS.) and (electrolyt\$2 same (ini or nickel))) and (resist or photoresist)  (338/614)).CCLS.) and (electrolyt\$2 same (ini or nickel))) and (resist or photoresist)  (338/614)).CCLS.) and (electrolyt\$2 same (ini or nickel))) and (resist or photoresist)				IBM_TDB	
(ni or nickel))  - 71 ((((438/612) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel))) and (resist or photoresist)  EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	-	92	1 ((()) +- (100) 010/ 01	USPAT;	2004/07/12
71 ((((438/612) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel))) and (resist or photoresist)  DERWENT;  IBM_TDB  USPAT;  US-PGPUB;  EPO; JPO;  DERWENT;				US-PGPUB;	10:10
- 71 ((((438/612) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel))) and (resist or photoresist)    TDB			(ni or nickel))	EPO; JPO;	
71 ((((438/612) or (438/613) or (438/614)).CCLS.) and (electrolyt\$2 same (ni or nickel))) and (resist or photoresist)  USPĀT; 2004/07/12 US-PGPUB; EPO; JPO; DERWENT;				DERWENT;	
(438/614)).CCLS.) and (electrolyt\$2 same (US-PGPUB; photoresist)  US-PGPUB; EPO; JPO; DERWENT;				IBM TDB	
(438/614)).CCLS.) and (electrolyt\$2 same (US-PGPUB; (ni or nickel))) and (resist or photoresist)  US-PGPUB; EPO; JPO; DERWENT;	-	71	((((438/612) or (438/613) or	USPAT;	2004/07/12
(ni or nickel))) and (resist or photoresist) EPO; JPO; DERWENT;			(438/614)).CCLS.) and (electrolyt\$2 same	US-PGPUB;	
photoresist) DERWENT;			(ni or nickel))) and (resist or		
			photoresist)		İ
IBM TDR			•	IBM TDB	1